PATENT ASSIGNMENT

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SUBMISSION TYPE: NEW ASSIGNMENT

NATURE OF CONVEYANCE: ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Michael D. Bradfield	01/26/2011

RECEIVING PARTY DATA

Name:	Remy Technologies, LLC	
Street Address:	600 Corporation Drive	
City:	Pendleton	
State/Country:	INDIANA	
Postal Code:	46064	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12942881

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER: 078944-023700

NAME OF SUBMITTER: Gerald L. Fellows

Total Attachments: 2

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PATENT REEL: 025716 FRAME: 0654 'H \$40.00 1294

ASSIGNMENT

WHEREAS, I, Michael D. Bradfield; the undersigned inventor and ASSIGNOR herein, have invented certain new inventions ROTOR LAMINATION COOLING SYSTEM AND METHOD, for which I have filed an Application of the same title on November 9, 2010, having U.S. Serial No. 12/942,881 and of which inventions and improvements I am an inventor; and

WHEREAS, **Remy Technologies**, **LLC**, a limited liability company registered under the laws of the state of Delaware and having an office located at 600 Corporation Drive, Pendleton, Indiana 46064, the ASSIGNEE herein, desires to acquire the entire right, title and interest in and to said inventions, applications and Letters Patent to be granted and issued thereon;

NOW, THEREFORE, for valuable consideration, the receipt and legal sufficiency of all of which is hereby acknowledged, I, the said ASSIGNOR, have sold and do hereby sell, assign, transfer and set over unto said ASSIGNEE, its successors and assigns, the entire right, title and interest in and to said inventions and all improvements thereon, in and to said application thereon, in and to applications pertaining to or based upon said inventions and applications, including utility, divisional, continuation, continuation-in-part and reissue applications, and in and to any and all Letters Patent, Invention Registrations, Utility Models, Extensions, Reissues or other patent rights which may be granted and issued on said inventions and applications, or any of them, not only for, to and in the United States of America, its territories and possessions, but for, to and in all countries foreign thereto, together with and including all priority rights based upon any and all applications in the United States of America and countries foreign covered by this Assignment.

And for the above-named considerations, I do hereby agree that I will, at the request of said ASSIGNEE, execute any and all applications for such Letters Patent for said inventions and any and all other papers and documents and do all other and further lawful acts that said ASSIGNEE may deem necessary or desirable to obtain such Letters Patent on said inventions, to secure the grant of such Letters Patent and to perfect and vest in the ASSIGNEE the entire right, title and interest in the inventions, applications, and such Letters Patent.

And for the above-named considerations, I do hereby authorize and empower the ASSIGNEE, its successors and assigns, to apply for and obtain, in its or their own names, such

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Letters Patent for the said inventions before competent International Authorities and in any and all countries foreign to the United States in which applications for such Letters Patent can be so made or such Letters Patent so obtained.

Dated:

address:

Witnessed By:

name: address: